

ABSTRACT OF DISCLOSURE

A chip light emitting diode having a wide viewing angle, and a fabrication method thereof.
The chip light emitting diode has a resin package sealing a light emitting chip which has at least one
5 curved projecting part. The curved projecting part has a cross section which is substantially
semicircular, or substantially or partially elliptical or parabolic. The curved projecting part preferably
has a cross section which is comprised of a plurality of straight lines, an angle being formed between
adjacent lines. The cross section is elongated to form a cylindrical outer surface of the resin package.

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